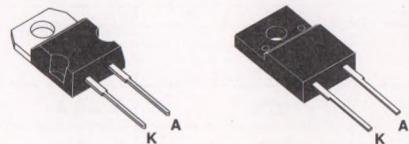


## FAST RECOVERY RECTIFIER DIODES

### FEATURES

- HIGH VOLTAGE CAPABILITY
- FAST AND SOFT RECOVERY
- INSULATED PACKAGE :  
insulating voltage = 2000V<sub>DC</sub>  
capacitance = 12 pF



### DESCRIPTION

Single chip rectifier suited for power conversion and polarity protection applications.

This device is packaged in TO220AC and in ISOWATT220AC.

### ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter			Value	Unit
I <sub>F</sub> (RMS)	RMS on-state current			12	A
I <sub>F</sub> (AV)	Average forward current $\delta = 0.5$	TO220AC	T <sub>c</sub> =130°C	6	A
		ISOWATT220AC	T <sub>c</sub> =105°C	6	
I <sub>FSM</sub>	Surge non repetitive forward current		t <sub>p</sub> =10ms sinusoidal	90	A
T <sub>stg</sub> T <sub>j</sub>	Storage and junction temperature range			- 65 to + 150 - 65 to + 150	°C °C

Symbol	Parameter	BYT71-(F)					Unit
		100	200	400	600	800	
V <sub>RRM</sub>	Repetitive peak off-state voltage	100	200	400	600	800	V

## THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
$R_{th}$ (j-c)	Junction to case	TO220AC	2.3
		ISOWATT220AC	4.9

## ELECTRICAL CHARACTERISTICS

## STATIC CHARACTERISTICS

Symbol	Test Conditions		Min.	Typ.	Max.	Unit
$I_R$ **	$T_j = 25^\circ C$	$V_R = V_{RRM}$			20	$\mu A$
	$T_j = 100^\circ C$				1	mA
$V_F$ *	$T_j = 100^\circ C$	$I_F = 6 A$			1.3	V
	$T_j = 25^\circ C$	$I_F = 6 A$			1.4	

Pulse test : \*  $t_p = 380 \mu s$ , duty cycle < 2 %\*\*  $t_p = 5 ms$ , duty cycle < 2 %

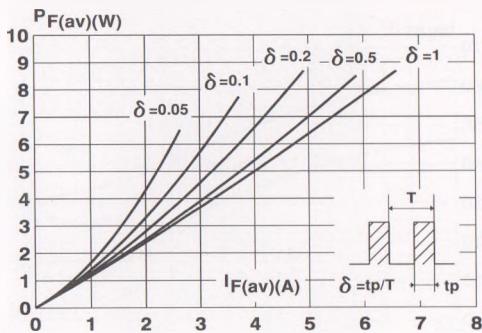
## RECOVERY CHARACTERISTICS

Symbol	Test Conditions		Min.	Typ.	Max.	Unit
$t_{rr}$	$T_j = 25^\circ C$	$I_F = 1A$ $V_R = 30V$	$dI_F/dt = -15A/\mu s$		300	ns

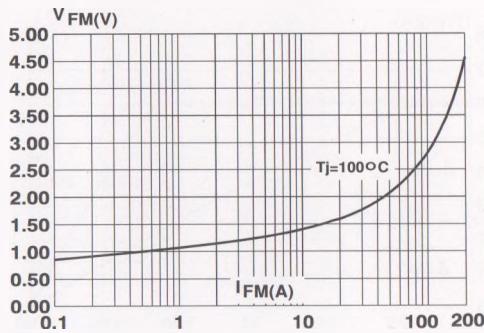
To evaluate the conduction losses use the following equations :

$$P = 1.15 \times I_F(AV) + 0.025 \times I_F^2(RMS)$$

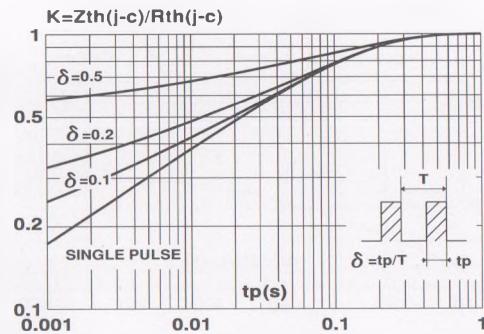
**Fig.1** : Average forward power dissipation versus average forward current.



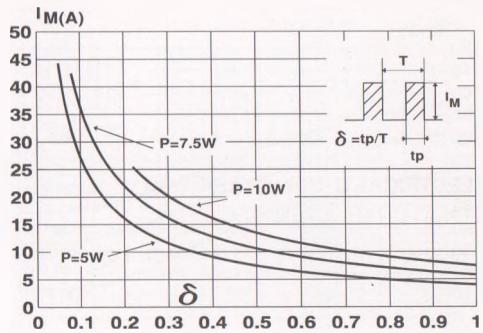
**Fig.3** : Forward voltage drop versus forward current (maximum values).



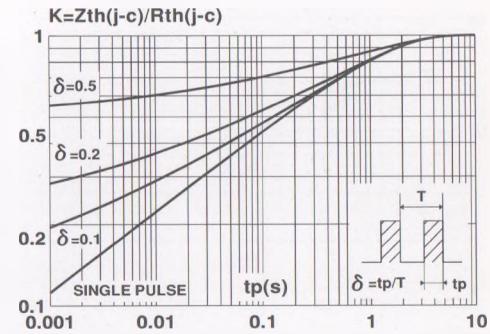
**Fig.4** : Relative variation of thermal impedance junction to case versus pulse duration.  
(TO 220 AC)



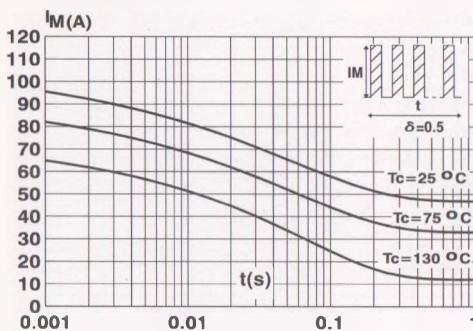
**Fig.2** : Peak current versus form factor.



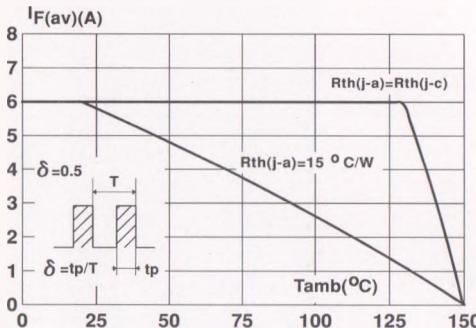
**Fig.5** : Relative variation of thermal impedance junction to case versus pulse duration.  
(ISOWATT220AC)



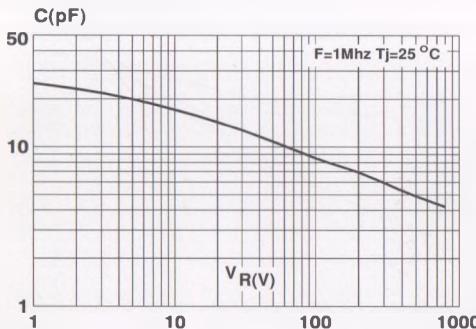
**Fig.6 : Non repetitive surge peak forward current versus overload duration.**  
(TO 220 AB)



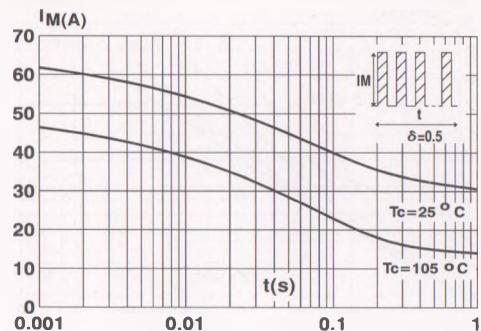
**Fig.8 : Average current versus ambient temperature.**  
(duty cycle : 0.5) (TO 220 AB)



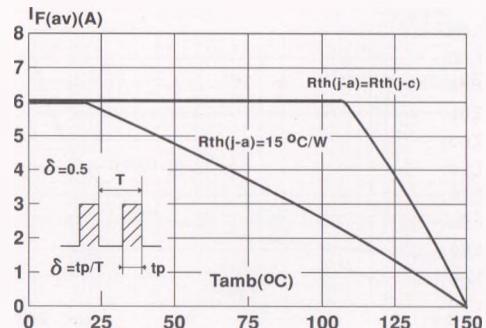
**Fig.10 : Junction capacitance versus reverse voltage applied (Typical values).**



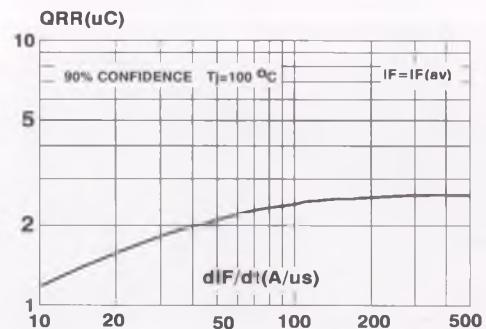
**Fig.7 : Non repetitive surge peak forward current versus overload duration.**  
(ISOWATT220AB)

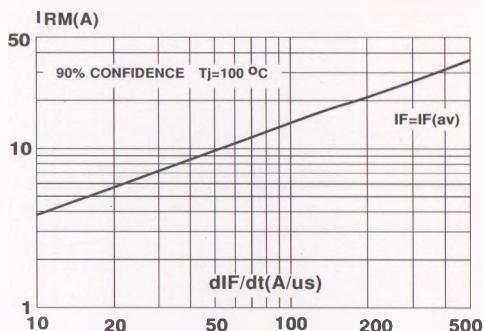
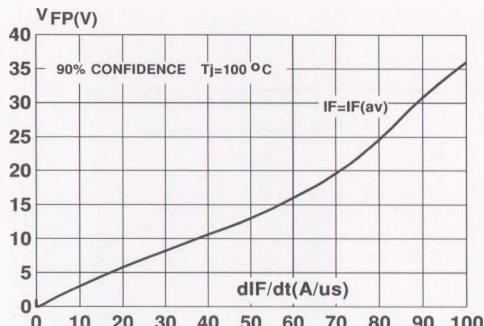
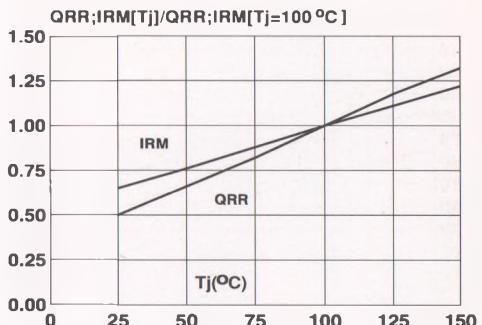


**Fig.9 : Average current versus ambient temperature.**  
(duty cycle : 0.5) (ISOWATT220AB)



**Fig.11 : Recovery charges versus dI/F/dt.**



**Fig.12** : Peak reverse current versus dIF/dt.**Fig.14** : Peak forward voltage versus dIF/dt.**Fig.13** : Dynamic parameters versus junction temperature.**Fig.15** : Recovery time versus dIF/dt.